

#### **TDA8133**

# +5.1 V and +8 V dual voltage regulator with disable and reset functions

#### **Features**

Input voltage range: 7 V to 18 VOutput currents up to 750 mA

■ Fixed precision output 1 voltage: 5.1 V ±2%

■ Fixed precision output 2 voltage: 8 V ±2%

Output 1 with reset function

■ Output 2 with disable function by TTL Input

■ Short-circuit protection at both outputs

■ Thermal protection

■ Low dropout voltage

#### **Description**

The TDA8133 and the TDA8133D are monolithic dual positive voltage regulators designed to provide fixed precision output voltages of 5.1 V and 8.0 V for currents up to 750 mA.

An internal reset circuit generates a reset pulse when the voltage of output 1 drops below the regulated voltage value.

Output 2 can be disabled via the TTL input

Short-circuit and thermal protections are included in all versions.

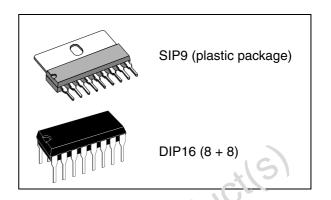
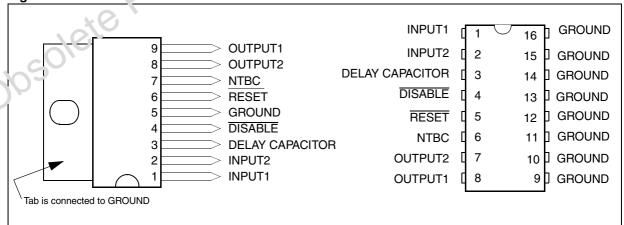


Table 1. Device summary

Order code	Packaging
TDA8133	Tray
TDA8133D	Tray





Contents TDA8133

## **Contents**

1	Description
2	Electrical characteristics4
3	Circuit description
4	Application diagrams8
5	Power dissipation and layout indications 9
6	Package mechanical data
7	Electrical characteristics

**TDA8133 Description** 

# **Description**

Figure 2. TDA8133 block diagram

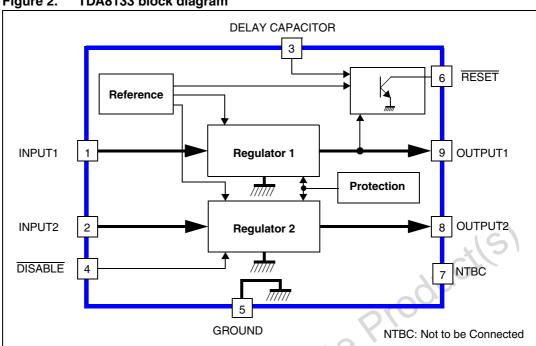
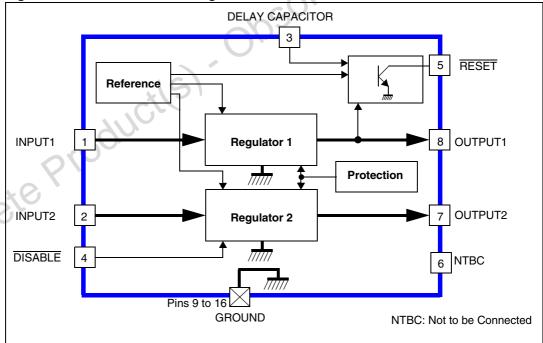


Figure 3. TDA8133D block diagram



Electrical characteristics TDA8133

# 2 Electrical characteristics

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>IN</sub>	DC input voltage at pins INPUT1 and INPUT2	20	V
V <sub>DIS</sub>	Disable input voltage at pin DISABLE	20	V
V <sub>RST</sub>	Output voltage at pin RESET	20	V
I <sub>O1,2</sub>	Output currents	Internally limited	
Pt	Power dissipation	Internally limited	
T <sub>STG</sub>	Storage temperature	-65 to +150	°C
T <sub>J</sub>	Junction temperature	0 to +150	°C

Table 3. Thermal data

Symbol	Parai	neter	Value	Unit
R <sub>thJC</sub>	Thermal resistance (junction-to-case)	TDA8133 TDA8133D		°C/W
R <sub>thJA</sub>	Thermal resistance <sup>(1)</sup> (junction-to-ambient)	TDA8133 TDA8133D		°C/W
TJ	Maximum recommended	l junction temperature	140	°C
T <sub>OPER</sub>	Operating free air tempe	rature range	0 to +70	°C

<sup>1.</sup> Mounted on board. For more information, refer to Section 5.

Table 4. Electrical characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>O1</sub>	Output voltage	I <sub>O1</sub> = 10 mA	5	5.1	5.2	V
V <sub>O2</sub>	Output voltage	I <sub>O2</sub> = 10 mA	7.84	8.00	8.16	V
V <sub>IO1,2</sub>	Dropout voltage	I <sub>O1,2</sub> = 750 mA			1.4	V
V <sub>O1,2LI</sub>	Line regulation	$7 \text{ V} < \text{V}_{\text{IN1}} < 14 \text{ V}$ $10 \text{ V} < \text{V}_{\text{IN2}} < 14 \text{ V}$ $I_{\text{O}1,2} = 200 \text{ mA}$			50 80	mV
V <sub>O1,2LO</sub>	Load regulation	5 mA < I <sub>O1</sub> < 600 mA 5 mA < I <sub>O2</sub> < 600 mA			100 160	mV
IQ	Quiescent current	I <sub>O1</sub> = 10 mA, OUTPUT2 Disabled			2	mA
V <sub>O1RST</sub>	Reset threshold voltage	$K = V_{O1}, \ V_{IN1} \ge 7 \ V$	K - 0.4	K - 0.25	K - 0.1	V
V <sub>RTH</sub>	Reset threshold hysteresis	See circuit description	20	50	75	mV
t <sub>RD</sub>	Reset pulse delay	C <sub>e</sub> = 100 nF See circuit description		25		ms

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>RL</sub>	Saturation voltage in reset condition	I <sub>RESET</sub> = 5 mA			0.4	V
I <sub>RH</sub>	Leakage current in normal condition	V <sub>RESET</sub> = 10 V			10	μΑ
K <sub>O1, 2</sub>	Output voltage thermal drift	$K_0 = \frac{\Delta V_0 \cdot 10^6}{\Delta T \cdot V_0}$ $T_J = 0 \text{ to } + 125^{\circ}\text{C}$		100		ppm/°C
I <sub>O1,2SC</sub>	Short circuit output current	$V_{IN1} = 7 \text{ V}, V_{IN2} = 10 \text{ V}$ $V_{IN1,2} = 16 \text{ V}^{(1)}$			1.6 1.0	А
V <sub>DISH</sub>	Disable voltage when pin DIS active)	SABLE is high (OUTPUT2	2			V
V <sub>DISL</sub>	Disable voltage when pin DIS disabled)	SABLE is low (OUTPUT2			0.8	V
I <sub>DIS</sub>	Disable bias current	0 V < V <sub>DIS</sub> < 7 V	-100		2	μΑ
T <sub>JSD</sub>	Junction temperature for the	rmal shutdown		145	11/0	°C

The output short-circuit currents are tested one channel at time. During a short-circuit, a large consumption of power occurs, but the thermal protection circuit prevents any excessive temperatures. A safe permanent short-circuit protection is only guaranteed for input voltages up to 16 V.

Note:  $T_{AMB} = 25^{\circ} C$ ,  $V_{IN1} = 7 V$ ,  $V_{IN2} = 10 V$ , unless otherwise specified.

Circuit description TDA8133

#### 3 Circuit description

The TDA8133 and the TDA8133D are dual-voltage regulators with reset and disable functions.

The two regulation parts are supplied from a single voltage reference circuit trimmed by zener zapping during EWS testing. Since the supply voltage of this voltage reference is connected to pin INPUT1 ( $V_{IN1}$ ), the second regulator will not work if pin INPUT1 is not supplied.

The output stages are designed using a Darlington configuration with a typical dropout voltage of 1.2 V.

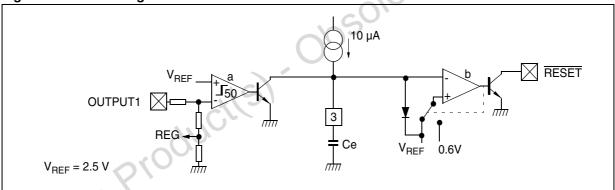
The disable circuit will switch off pin OUTPUT2 if a voltage less than 0.8 V is applied to pin DISABLE.

The reset circuit checks the voltage at pin OUTPUT1. If this voltage drops below  $V_{O1}$  - 0.25 V (4.85 V Typ.), the "a" comparator (*Figure 4*) rapidly discharges the external capacitor (Ce) and the reset output immediately switches to low. When the voltage at pin OUTPUT1 exceeds  $V_{O1}$  - 0.2 V (4.9 V Typ.), the  $V_{Ce}$  voltage increases linearly to the reference voltage ( $V_{REF}$  = 2.5 V) corresponding to a reset pulse delay ( $t_{RD}$ ) as shown in *Figure 5*.

$$t_{RD} = \frac{C_e \times 2.5V}{10\mu A}$$

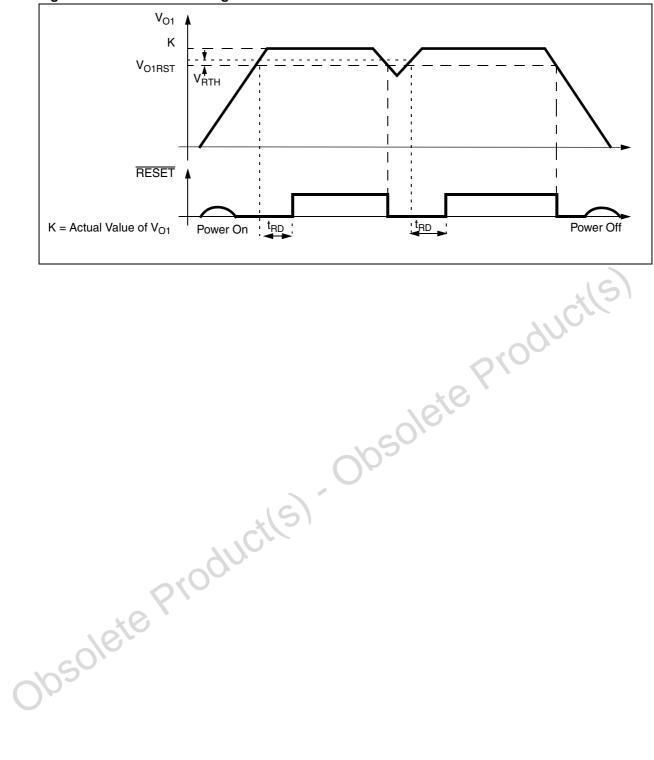
Afterwards, the reset output returns to high. To avoid glitches in the reset output, the second comparator "b" has a large hysteresis (1.9 V).

Figure 4. Reset diagram



TDA8133 Circuit description

Figure 5. Internal reset diagram



#### **Application diagrams** 4

Figure 6. **TDA8133 typical application** 

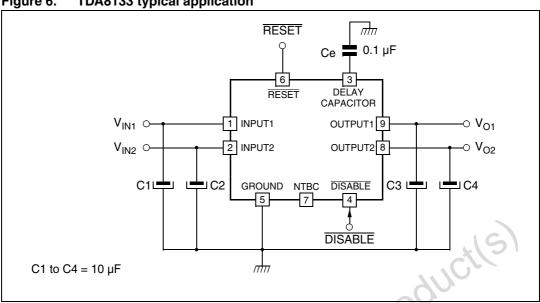
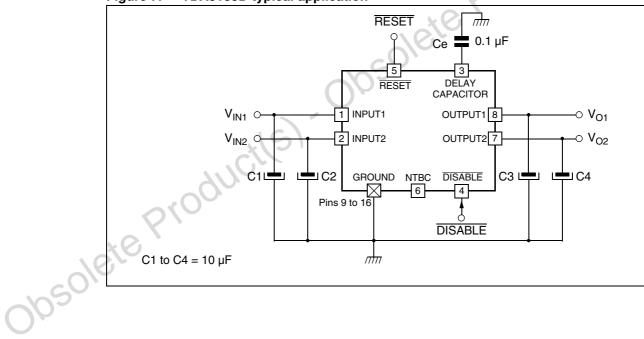


Figure 7. **TDA8133D typical application** 



## 5 Power dissipation and layout indications

The power is mainly dissipated by the two device buffers. It can be calculated by the equation:

$$P = (V_{IN1}-V_{O1}) \times I_{O1} + (V_{IN2}-V_{O2}) \times I_{O2}$$

The following table lists the different  $R_{thJA}$  values of these packages with or without a heat sink and the corresponding maximum power dissipation assuming:

- Maximum ambient temperature = 70° C
- Maximum junction temperature = 140° C

Table 5. Power dissipation

Device	Heat Sink	R <sub>thJA</sub> in °C/W	P <sub>MAX</sub> in W
TDA8133	No	50	1.4
TDA6133	Yes	20	3.5
TDA8133D	No	56 to 40	1.25 to 1.75
IDAGISSD	Yes	32	2.2

Figure 8. Thermal resistance (junction-to-ambient) for DIP16 package without heatsink

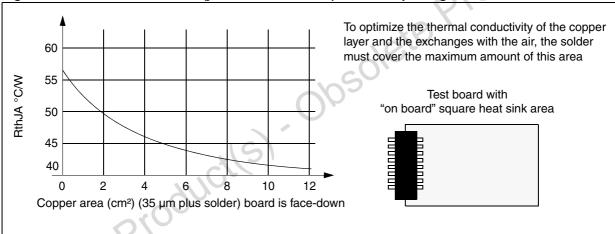
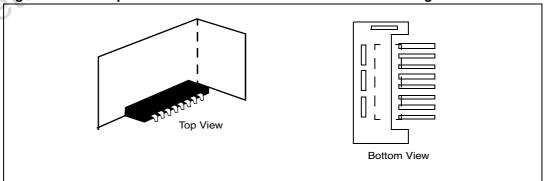


Figure 9. Metal plate mounted near the TDA8133D for heatsinking



# 6 Package mechanical data

Figure 10. 9-pin plastic single in-line package

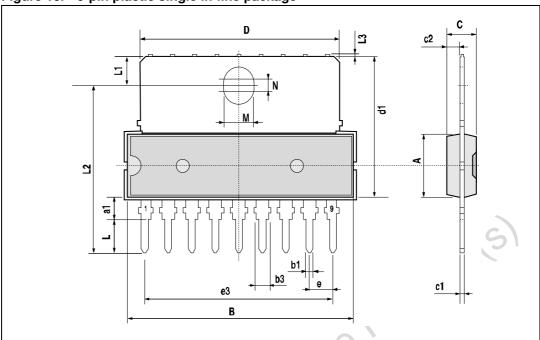


Table 6. 9-pin plastic single in-line package dimensions

	Dim.		mm	ans'		Inches	
	Dilli.	Min.	Тур.	Max.	Min.	Тур.	Max.
	Α			7.1			0.280
	a1	2.7	1621	3	0.106		0.118
	В	111		24.8			0.976
	b1	0,0	0.5			0.020	
	b3	0.85		1.6	0.033		0.063
	С		3.3			0.130	
10	c1		0.43			0.017	
cO//	c2		1.32			0.052	
000	D			21.2			0.835
O	d1		14.5			0.571	
	е		2.54			0.100	
	e3		20.32			0.800	
	L	3.1	_		1.122		
	L1		3			0.116	
	L2		17.6			0.693	

Table 6. 9-pin plastic single in-line package dimensions (continued)

Dim		mm			Inches	
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.
L3			0.25			0.010
М		3.2			0.126	
N		1			0.039	

Figure 11. 16-pin plastic dual in-line package, 300 mil width

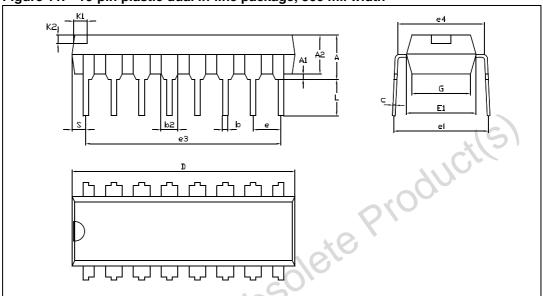


Table 7. 16-pin plastic dual in-line package dimensions

Dim.		mm			Inches	
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.
A		10,0	5.33			0.210
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.115	0.130	0.195
b	0.36		0.56	0.014		0.022
b2		1.52	1.78		0.060	0.070
c S	0.20	0.25	0.36	0.008	0.010	0.014
D	18.67	19.18	19.69	0.735	0.755	0.775
е		2.54			0.100	
E1	6.10	6.35	7.11	0.240	0.250	0.280
L	2.92	3.30	3.81	0.115	0.130	0.150

## 6.1 Environmentally-friendly packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance.

ECOPACK specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK is an ST trademark.

Obsolete Product(s). Obsolete Product(s)

TDA8133 Revision history

# 7 Revision history

Table 8. Document revision history

March 1994	Revision	Changes
	1.0	First issue
July 2001	1.1	Datasheet update and addition of DIP16 package
August 2001	1.2	General update; DISABLE pin renamed DISABLE (function remains unchanged)
September 2001	1.3	Thermal data updated
October 2001	1.4	Thermal data updated. Figure 2 and Figure 3 updated
05-Mar-2009	2	Preliminary banner removed, template updated and Section 6.1 added
		Preliminary banner removed, template updated and Section 6.1 added

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